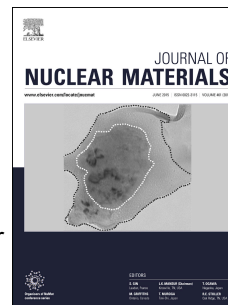


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Immobilization of iodine via copper iodide

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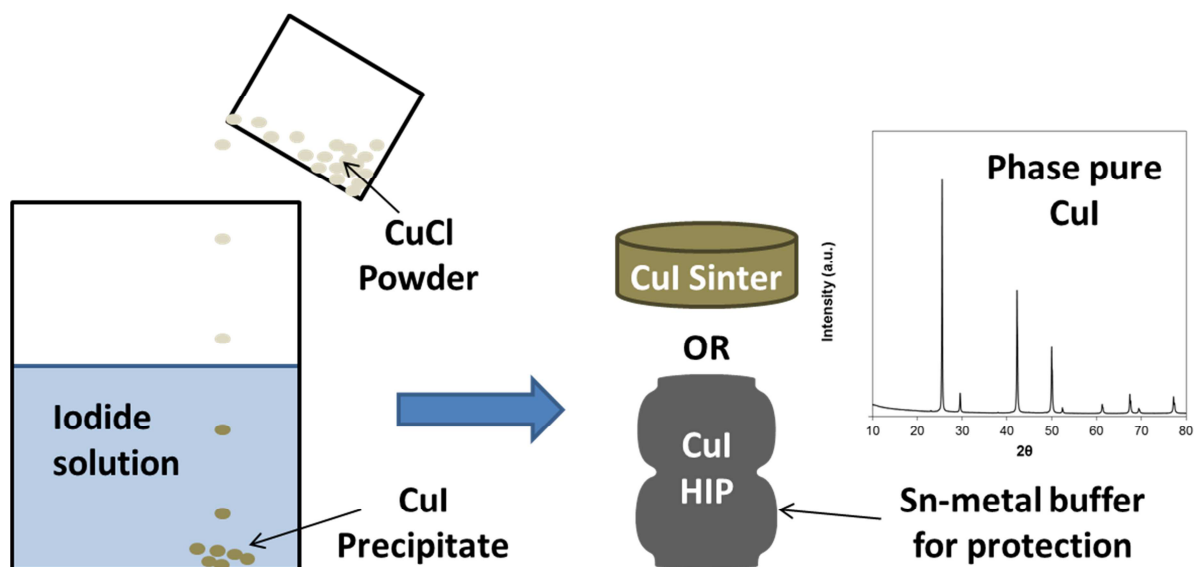
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Graphical Abstract



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